



Peter Lefkin
MIPI Alliance

State of the Alliance

**MIPI ALLIANCE
DEVELOPERS
CONFERENCE
TAIPEI
18 OCTOBER 2019**

[MIPI.ORG/DEVCON](https://mipi.org/devcon)

2003

THE CELLPHONE MARKET



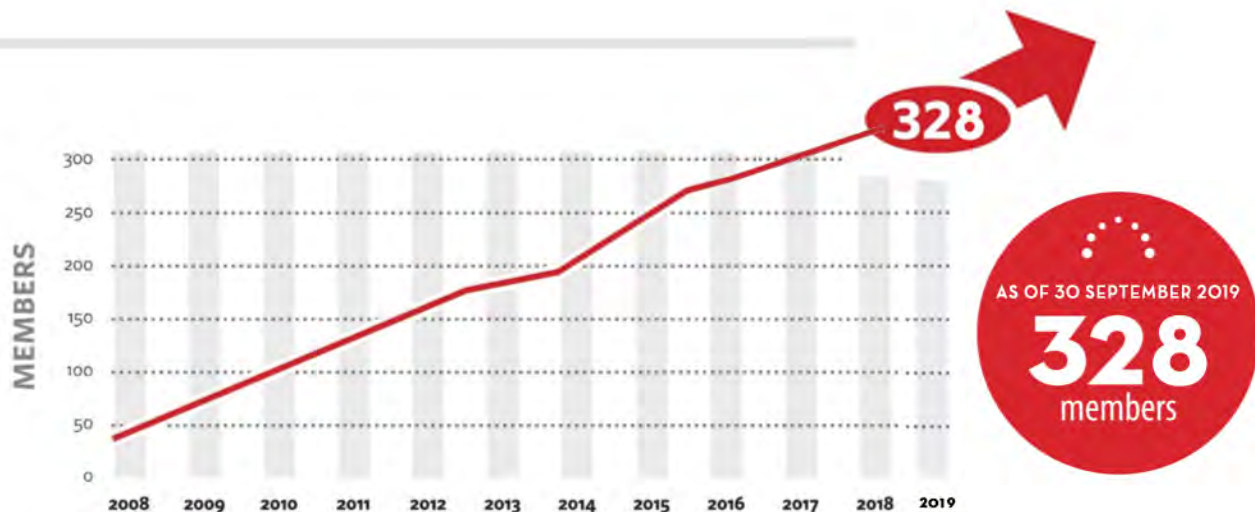
2003

**MIPI ALLIANCE
FORMED TO
STANDARDIZE
CAMERA AND
DISPLAY
INTERFACES**



MIPI Alliance Membership

MEMBERSHIP
CONTINUES
YEAR-OVER-
YEAR GROWTH



27 Countries with MIPI members

MIPI Members in Taiwan

Adopter Members

Aspeed Technology Inc.	JMicon Technology Corp.
Chroma Ate Inc.	King Yuan Electronics Co. Ltd.
Elan MicroElectronics Corp.	Novatek Microelectronics Corp.
Explore Microelectronics Inc.	PixArt Imaging Inc.
Fitipower Integrated Technology Inc.	Raydium Semiconductor Corp.
FocalTech Systems Co., Ltd.	RichWave Technology Corporation
Global Unichip Corp.	Silicon Optronics, Inc.
Himax Technologies Inc.	Sitronix Technology Corp.
HTC Corporation	Sonix Technology Co. Ltd.
iCatch Technology, Inc.	Sunplus Innovation Technology, Inc.
Ili Technology Corp.	Walsin Technology Corporation
iSentek Inc.	Wistron Corporation
ITE Tech. Inc.	



Contributor Members

- M31 Technology Corp.
- MediaTek Inc.
- Phison Electronics Corporation
- Realtek Semiconductor Corp.
- Silicon Motion, Inc.

Board and Contributor Members

Contributor Members

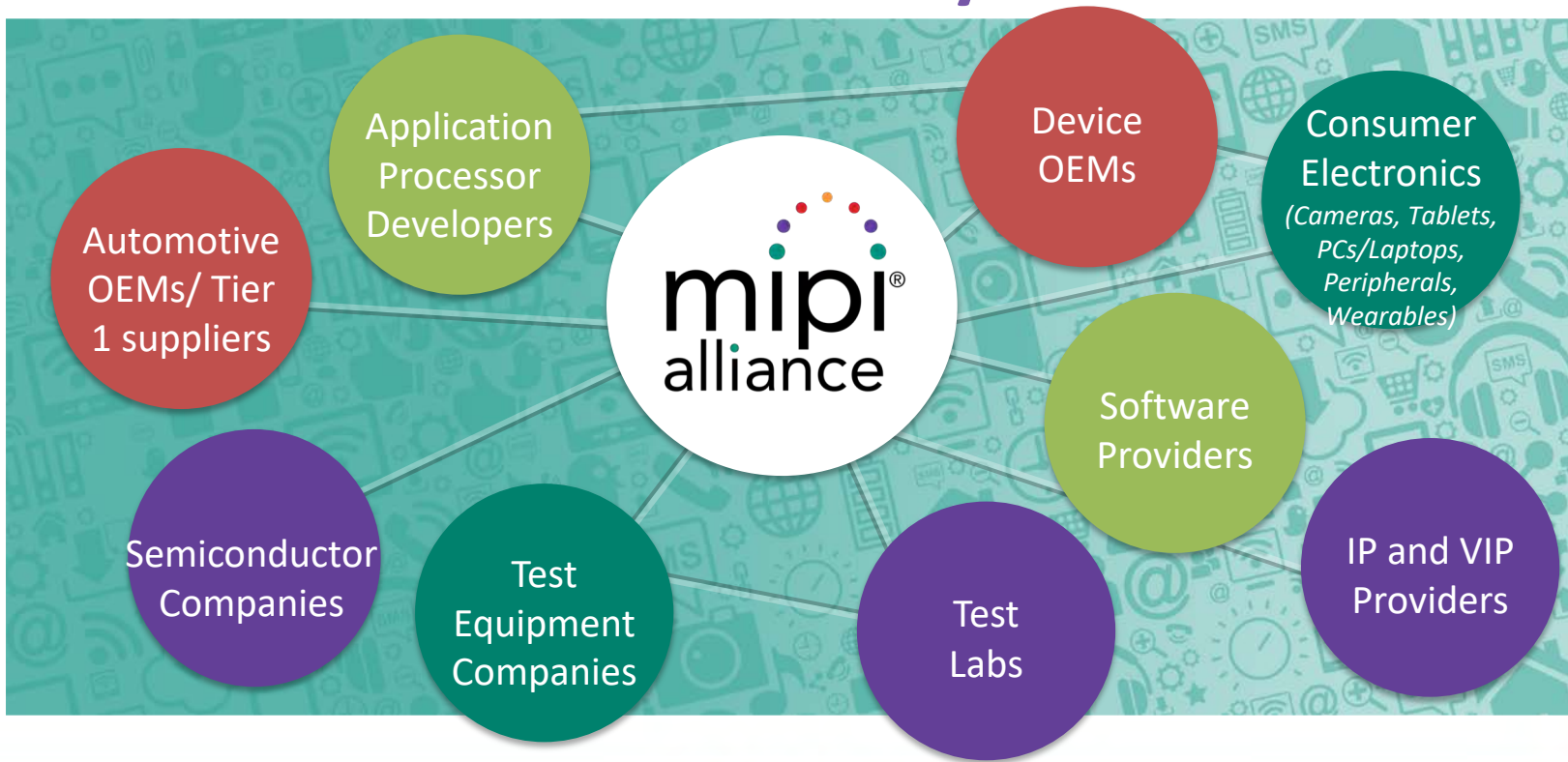


Board Members



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MIPI Alliance Member Ecosystem



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MIPI Specifications Today

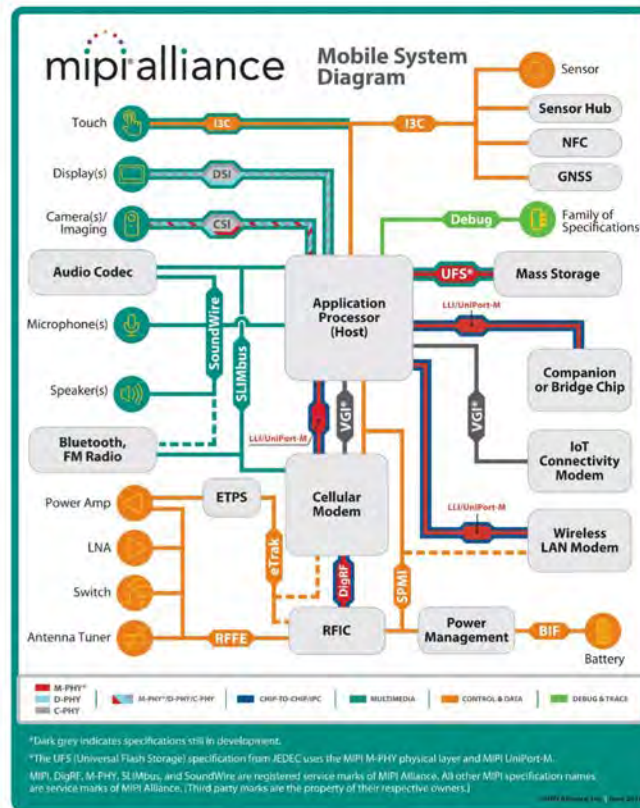
Number of current specifications

48+

MIPI specifications are crafted with these 3 key attributes:

- 1 Low power
- 2 High-bandwidth
- 3 Low electromagnetic interference (EMI)

All MIPI specifications are offered royalty-free for MIPI members



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MIPI Specifications Leveraged Beyond Mobile



MIPI SPECIFICATIONS
CAN BE FOUND IN
BILLIONS OF DEVICES
AND IN EVERY
SMARTPHONE ON
THE MARKET

2019 MIPI Specifications

8

MIPI
Specifications
Expected by
Year End

Adopted in 2019

SOUNDWIRE v1.2

SPP v2.0

C-PHY v2.0

DISCO FOR I3C v1.0

CSI-2 v3.0

Targeted for Completion This Year

I3C v1.1

CCS v1.1

MIPI D-PHY v2.5



**Areas of Focus &
Recent Activities**

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The Mobile Evolution to 5G

Maintaining MIPI Leadership

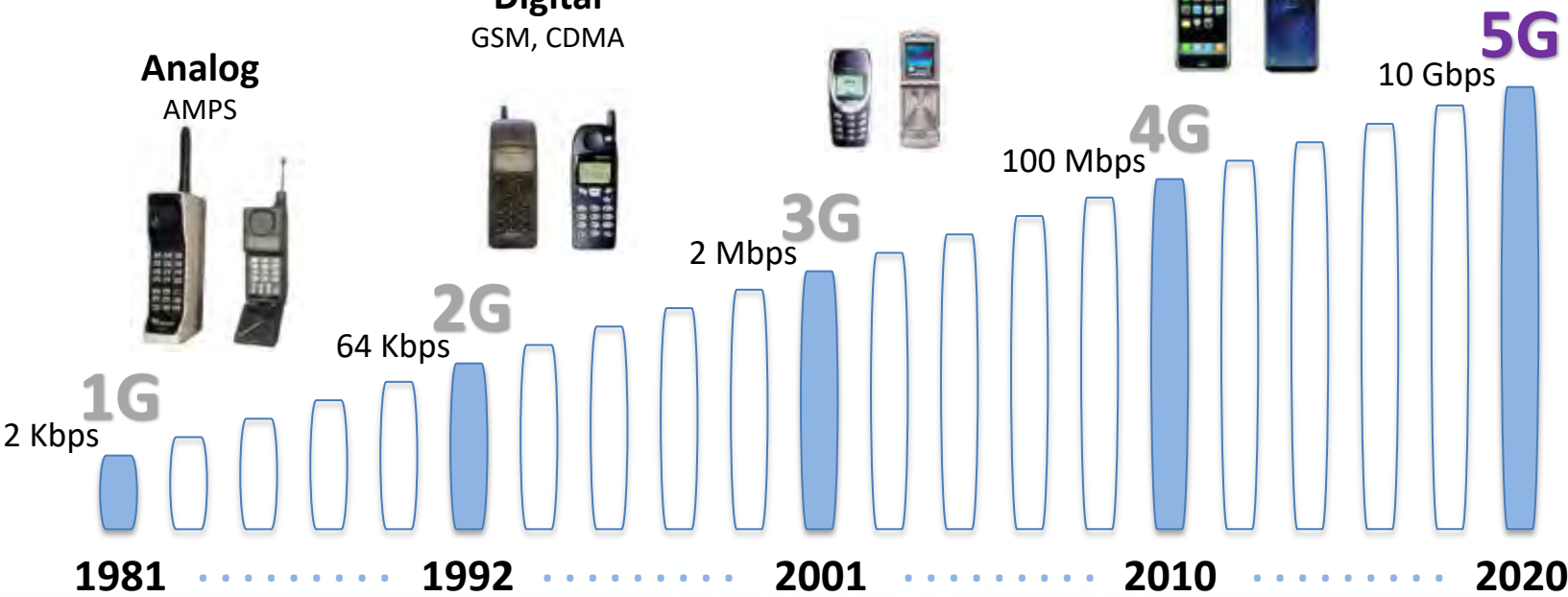
Mobile Platform

Mobile Broadband
LTE, LTE-A

Mobile Data
HSPA, EVDO

Digital
GSM, CDMA

Analog
AMPS



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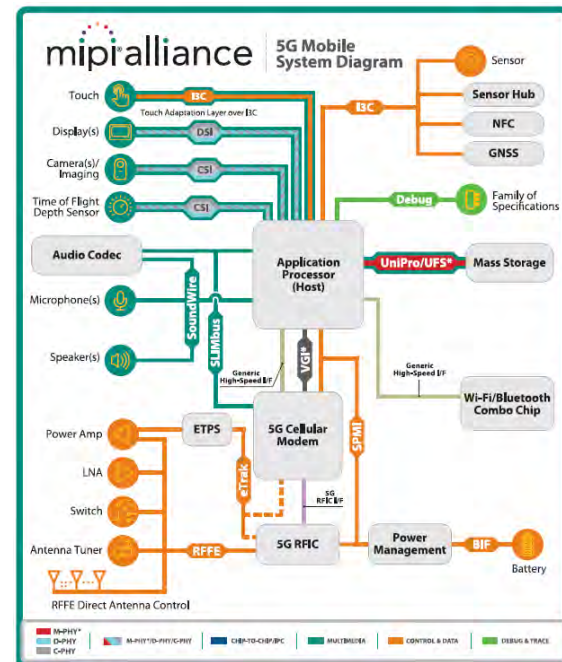
Implications of 5G for MIPI Specifications

Considerations:

- 5G is not just mobile - broader application use cases
- 5G NR - key RF technology innovations
- Changing requirements: performance, reach, power, etc.

Examples of potential impacts / implications:

- **MIPI RFFESM** – Massive MIMO, mmWave
- **MIPI CSI-2SM** – Movement from camera to vision and imaging in emerging use cases
- **MIPI DSI-2SM** – Increase in display resolution, reach, expansion to touch and XR use cases
- **MIPI I3C[®]** – More and more highly accurate sensors



Learn more about MIPI RFFE development in today's program

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White Paper Assesses MIPI's 5G Readiness

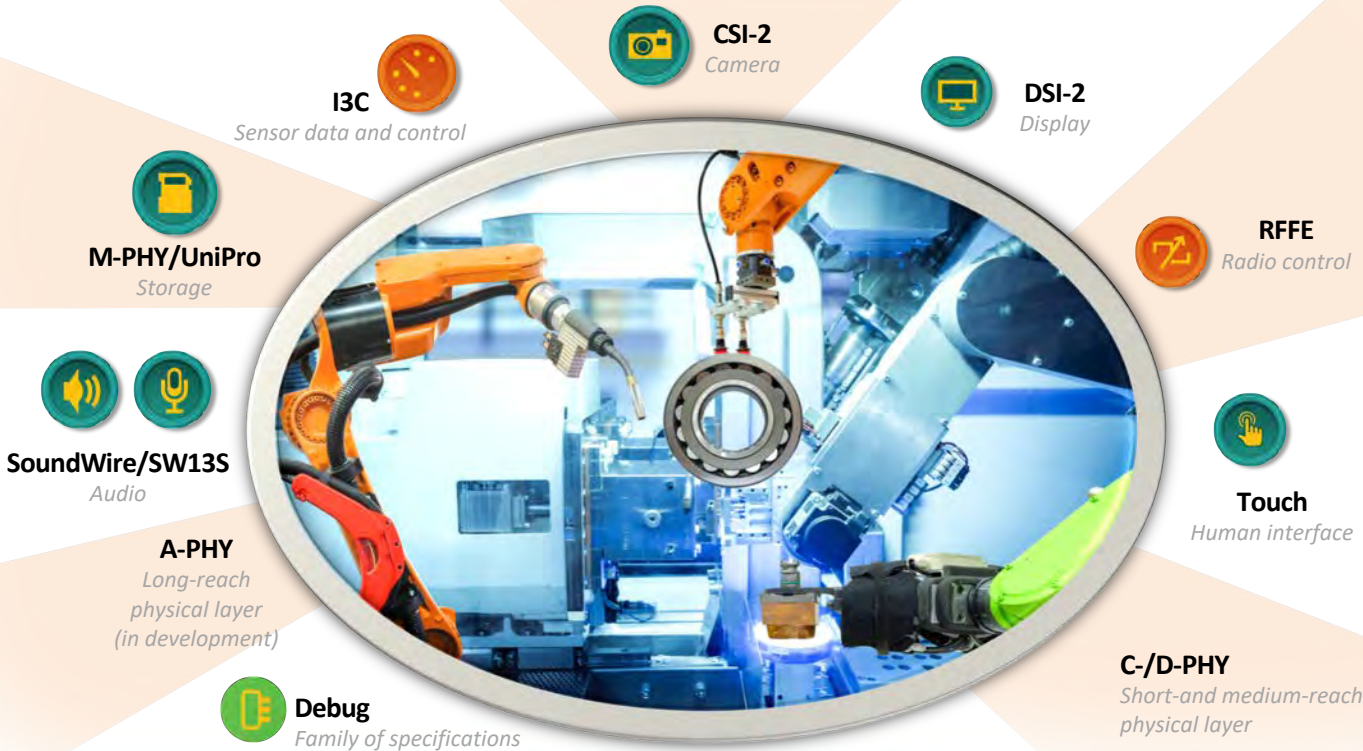


- Provides an overview and main use cases for 5G
- Details how each specification meets industry bandwidth, performance and feature requirements for a wide variety of 5G use cases
- **All MIPI specifications relevant for applications in mobile platforms were found to be 5G ready**
- Continued work underway for beyond mobile applications



<https://mipi.org/mipi-specification-5g-readiness-assessment>

Leveraging MIPI Specifications in IoT



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Automotive & A-PHY

CSI-2

Camera Serial Interface protocol
Protocol for cameras, lidar, radar sensors

DSI-2

Display Serial Interface protocol
Protocol for smartphone, IOT and automotive displays

C-PHY

3-phase physical layer for CSI-2 & DSI-2
Short-reach physical layer for cameras and displays

D-PHY

Differential physical layer for CSI-2 & DSI-2
Short-reach physical layer for cameras and displays

I3C

Control and data bus protocol and interface
Sensor and general purpose data and control interface within a module

RFFE

RF control protocol
Front end control within a wireless module

SoundWire & SWI3S

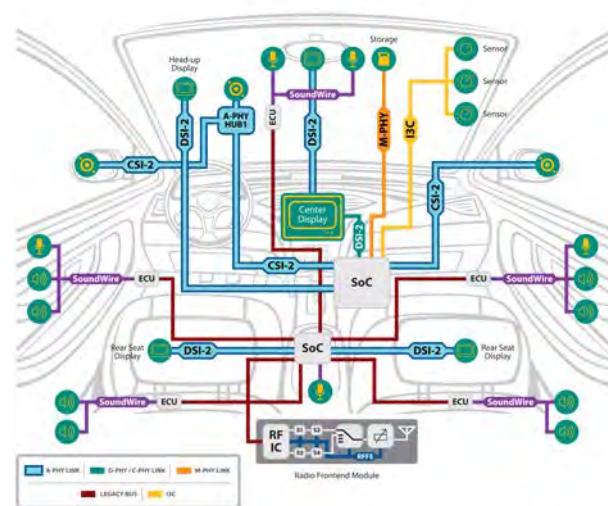
Digital audio and control interface
Audio interface within a module

UniPro for UFS

Data transport protocol for UFS over M-PHY
Transport protocol for UFS storage

M-PHY for UFS

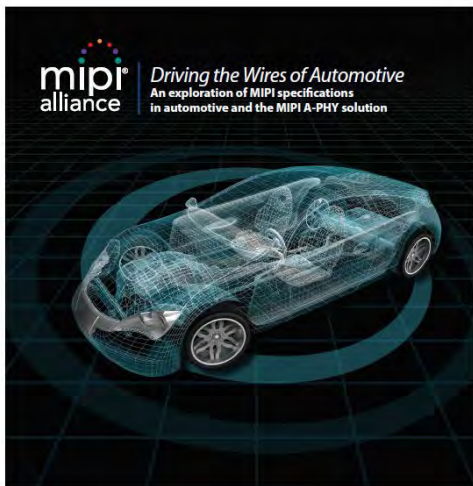
Differential physical layer for UFS storage
Short-reach physical transport for UFS storage



MIPI Automotive Infotainment System Diagram



Automotive & A-PHY



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New MIPI in Automotive White Paper

- Why MIPI specifications are being leveraged in automotive
- An overview of each MIPI specifications used in automotive today
- An in-depth look at the upcoming MIPI A-PHY



Sign up for the automotive email list and look for upcoming MIPI webinars

Visit mipi.org to download the paper

Camera

Building Capabilities for Greater Machine Awareness



CSI-2 v3.0 New Features:

Unified Serial Link

for encapsulating connections between an image sensor module and application processor

Crucial for reducing the number of wires in a variety of platforms

Smart Region of Interest

for analyzing images, inferencing algorithms and making better deductions

Could enable medical devices to more surely recognize anomalies such as tumors

RAW-24

for representing individual image pixels with 24-bit precision

Could enable an autonomous vehicle to decipher whether darkness is a harmless shadow or a pothole

IN CSI-2 v4.0:

- Always On Sentinel Controller (AOSC)
- Functional Safety (FSAF)
- Imaging Security (ISEC)
- Adaptation Layer (ADAPL) for A-PHY

Debug Specs Publicly Available

MIPI SneakPeek Protocol (MIPI SPP) v2.0 introduces MIPI TinySPP, a style of SneakPeek for low-bandwidth and potentially high-latency interfaces

MIPI System Software-Trace (MIPI SyS-T), a universal data format for transmitting software debug and trace information

MIPI Narrow Interface for Debug and Test (MIPI NIDnT), a specification that allows the use of functional ports on a device for debug/testing of finished products

MIPI System Trace Protocol (MIPI STP), a base protocol for application-specific trace functions

MIPI Trace Wrapper Protocol (MIPI TWP), a protocol enabling multiple source trace streams to be combined into a single trace stream

MIPI High-Speed Trace Interface (MIPI HTI) and **MIPI Parallel Trace Interface** (MIPI PTI), for exporting trace data

MIPI Gigabit Debug for USB (MIPI GbD USB) and **MIPI Gigabit Debug for IP Sockets** (MIPI GbD IPS), techniques for using the SPP and TWP protocols over USB and IP sockets



Security Investigation Group

Purpose:

- Look at security efforts holistically across MIPI
- Determine a broader strategy and set of requirements that could provide working groups with a consistent solution

Deliverables:

- Recommend a MIPI security framework
- Provide documented guidance to working groups, including overarching requirements for MIPI and its members, and guiding principles for the work to be done
- Deliver recommendation(s) for the ongoing support model at the conclusion of the Security IG's work



Wires Behind Wireless Blog

In the blog:

- Information on **new features and specification releases**
- **Use cases and applications** of MIPI specifications
- **Q&As** with working group chairs and other experts
- Latest **MIPI Alliance news**
- **Highlights and key takeaways** from webinars and MIPI DevCon presentations
- Details of MIPI participation in **industry events**

www.mipi.org/blog



The screenshot shows the MIPI Alliance website header with navigation links: About Us, Membership, Specifications, Resources, and News. The main content area features a blog post titled "MIPI CSI-2's Newest Frontier: Machine Awareness" written by Haran Thanigasalam, Chair of the MIPI Camera Working Group, dated 27 September 2019. The post text discusses the challenges of machine perception and the benefits of machine awareness. A "Read More" button is visible at the bottom of the post. To the right of the text is a graphic for the "NEW SPECIFICATION MIPI CSI-2 v3.0" with the tagline "Designed to enable greater machine awareness across multiple platforms".



THANK
YOU

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